International TOR Rectifier

POWER MOSFET THRU-HOLE (TO-257AA)

IRFY9130C,IRFY9130CM 100V, P-CHANNEL HEXFET MOSFET TECHNOLOGY

Product Summary

Part Number	RDS(on)	ΙD	Eyelets	
IRFY9130C	0.3 Ω	-11.2A	Ceramic	
IRFY9130CM	0.3Ω	-11.2A	Ceramic	

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Ceramic Eyelets
- Ideally Suited For Space Level Applications

Absolute Maximum Ratings

	Parameter		Units
ID @ VGS = -10V, TC = 25°C	Continuous Drain Current	-11.2	
ID @ VGS = -10V, TC = 100°C	Continuous Drain Current	-7.1	A
IDM	Pulsed Drain Current ①	-44	
P _D @ T _C = 25°C	Max. Power Dissipation	75	W
	Linear Derating Factor	0.6	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	400	mJ
IAR	Avalanche Current ①	-11.2	Α
EAR	Repetitive Avalanche Energy ①	7.5	mJ
dv/dt	Peak Diode Recovery dv/dt 3	-5.5	V/ns
TJ	Operating Junction	-55 to 150	
TSTG	Storage Temperature Range		°C
	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)	
	Weight	4.3 (Typical)	g

For footnotes refer to the last page

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	-100	_	_	V	$V_{GS} = 0V, I_{D} = -1.0mA$
ΔBVDSS/ΔTJ	Temperature Coefficient of Breakdown Voltage	_	-0.1	_	V/°C	Reference to 25°C, I _D = -1.0mA
RDS(on)	Static Drain-to-Source On-State Resistance	_	_	0.30	Ω	VGS = -10V, ID = -7.1A _④
VGS(th)	Gate Threshold Voltage	-2.0	_	-4.0	V	$V_{DS} = V_{GS}$, $I_{D} = -250\mu A$
9fs	Forward Transconductance	2.5	_	_	S (7)	V _{DS} > -15V, I _{DS} = -7.1A ④
IDSS	Zero Gate Voltage Drain Current		_	-25	μА	V _{DS} = -80V ,V _{GS} =0V
		_	—	-250	μ.Α.	V _{DS} = -80V,
						VGS = 0V, TJ = 125°C
IGSS	Gate-to-Source Leakage Forward	_	_	-100	nA	V _{GS} = -20V
IGSS	Gate-to-Source Leakage Reverse		_	100	nA	VGS = 20V
Qg	Total Gate Charge	_	_	30		VGS = -10V, ID = -11.2A
Qgs	Gate-to-Source Charge	_	_	7.1	nC	V _{DS} = -50V
Q _{gd}	Gate-to-Drain ('Miller') Charge	_	_	2.1		
td(on)	Turn-On Delay Time		_	60		V _{DD} = -50V, I _D = -11.2A,
tr	Rise Time	_	_	140		$R_G = 7.5\Omega$
td(off)	Turn-Off Delay Time	_	_	140	ns	
tf	Fall Time		_	140		
LS+LD	Total Inductance	_	6.8	_	nΗ	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
C _{iss}	Input Capacitance	_	800	_		VGS = 0V, VDS = -25V
Coss	Output Capacitance	_	350	_	pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	_	125	_		

Source-Drain Diode Ratings and Characteristics

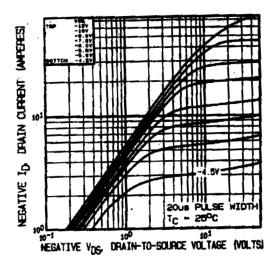
	Parameter	N	/lin	Тур	Max	Units	Test Conditions
Is	Continuous Source Current (Body Die	ode) -	_	_	-11.2	۸	
ISM	Pulse Source Current (Body Diode)	D -	_	_	-44	Α	
VSD	Diode Forward Voltage		_	_	-4.7	٧	$T_j = 25$ °C, $I_S = -11.2$ A, $V_{GS} = 0$ V ④
t _{rr}	Reverse Recovery Time		-	_	250	nS	Tj = 25°C, IF = -11.2A, di/dt \leq -100A/μs
QRR	Reverse Recovery Charge	-	_	_	3.0	μC	V _{DD} ≤ -50V ④
ton	Forward Turn-On Time Intrinsic to	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$.					

Thermal Resistance

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	_	_	1.67		
RthCS	Case-to-sink	_	0.21	_	°C/W	
RthJA	Junction-to-Ambient	_	_	80		Typical socket mount

Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last page



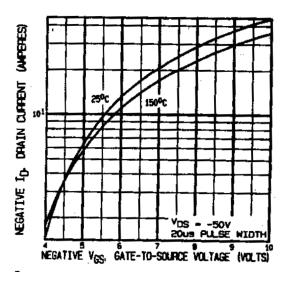
SOUS PULSE WIDTH

TC = 150°C

NEGATIVE VDS. URAIN-70-SOURCE VOLTAGE (VOLTS)

Fig 1. Typical Output Characteristics







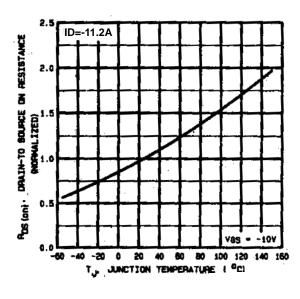


Fig 4. Normalized On-Resistance Vs. Temperature

www.irf.com 3

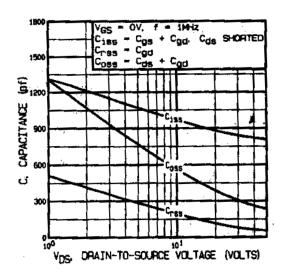


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

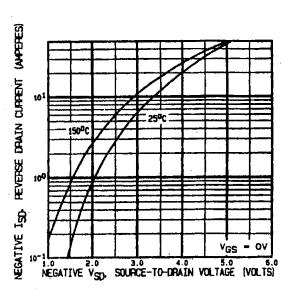


Fig 7. Typical Source-Drain Diode Forward Voltage

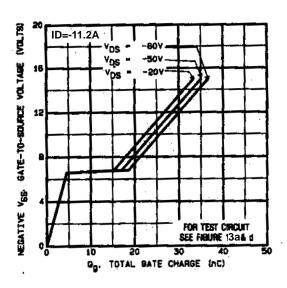


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

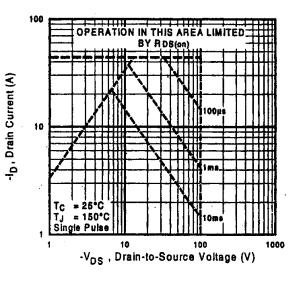


Fig 8. Maximum Safe Operating Area

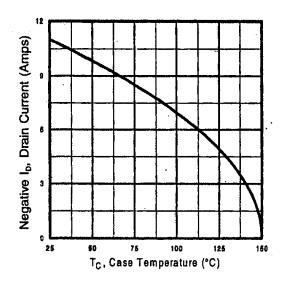


Fig 9. Maximum Drain Current Vs. Case Temperature

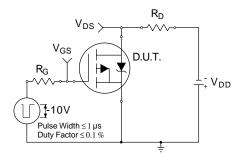


Fig 10a. Switching Time Test Circuit

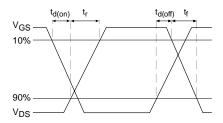


Fig 10b. Switching Time Waveforms

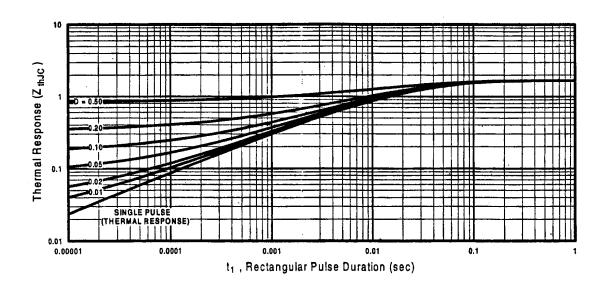


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

www.irf.com 5

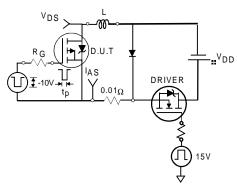


Fig 12a. Unclamped Inductive Test Circuit

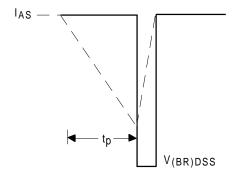


Fig 12b. Unclamped Inductive Waveforms

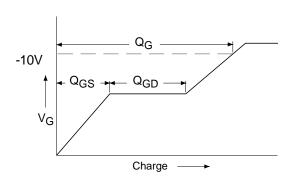


Fig 13a. Basic Gate Charge Waveform

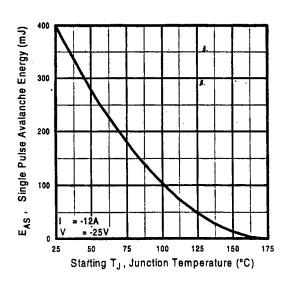


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

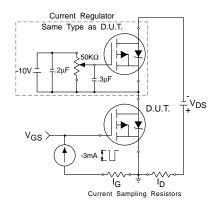


Fig 13b. Gate Charge Test Circuit

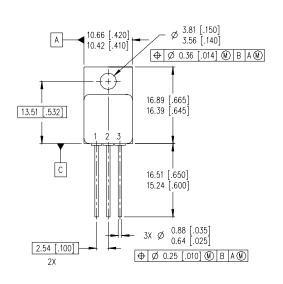
6 www.irf.com

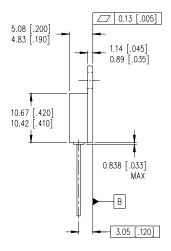


Foot Notes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② $V_{DD} = -25V$, starting $T_{J} = 25^{\circ}C$, L = 6.4mHPeak $I_{L} = -11.2A$, $V_{GS} = -10V$
- ③ ISD ≤ -11.2A, di/dt ≤ -140A/ μ s, VDD ≤ -100V, TJ ≤ 150°C
- ④ Pulse width ≤ 300 μ s; Duty Cycle ≤ 2%

Case Outline and Dimensions — TO-257AA

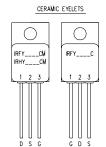




NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.





International TOR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information. Data and specifications subject to change without notice. 04/01